

3 LIST OF PATENTS AND OTHER ITEMS FOR APPLICANT'S
INFORMATION DISCLOSURE STATEMENT

APPLICANT:

«Inventors PTOfilings»

FILING DATE:

«FilingDate»

GROUP:

«ArtUnit» 2835

DEC 20 2001 (Use several sheets if necessary)

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE
GM	AA	5,489,805	02/06/96	Hackitt et al.	—	—	06/01/95
GM	AB	6,008,988	12/28/99	Palmer	—	—	02/25/97
GM	AC	6,219,243	04/17/01	Ma et al.	—	—	12/14/99

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)

GM	AD	Bath, J., Selectron Corp., <i>Lead Free Process Group Update</i> , National Electronics Manufacturing Initiative, Jan. 17, 2001
GM	AE	DeBiase, J., <i>Organic Solderability Preservatives: Benzotriazoles and Substituted Benzotrimidazoles</i> , Proceedings of the SMTA, 1996
GMT	AF	<i>Double Sided 4Mb SRAM Coupled Cap PBGA Card Assembly Guide</i> , IBM Application Note, Feb, 1998
GMT	AG	Hart, K., et al., <i>DFE Study Gives Alternative Finishes the Green Light</i> , PC Fab, Oct. 2000
GT	AH	Johnson, R.W., et al., <i>Thermal Cycle Reliability of Solder Joints to Alternate Plating Finishes</i> , paper from Auburn University, 2000
GM	AI	<i>Kester Solder Paste for Surface Mount and General Electronics Assemblies</i> , Online Catalog of Preferred Products, 2001
GM	AJ	Morawska, Z., et al., <i>Lead-Free Solderability Preservative Coatings for PCBs</i> , Advanced Microelectronics, v. 28, no. 3, May/June 2001
GM	AK	Parquet, D., et al, <i>OSP: The High Performance Surface Finish</i> , Electronic Interconnect Conference, 1997
GMT	AL	Romm, D., et al., <i>Evaluation of Ni/Pd – Finished ICs with Lead Free Solder Alloys</i> , Texas Instruments Application Report SZZA024, Jan. 2001
GM	AM	Solberg, V., <i>Impact of PCB Surface Finish on SMT Assembly Process Yield</i> , Application Note from Tessera Corp.
GM	AN	Syed, A., Amkor Technology Corp., <i>Surface Mount Requirements for Advanced Packaging Solutions</i> , 2000
GMT	AO	Wengenroth, K., et al., <i>OSPs: Addressing Future Surface Finish Needs</i> , Proceedings of the SMTA, 2000, (Abstract)
	AP	
	AQ	

EXAMINER:

GM Tolini

DATE CONSIDERED:

12/15/02

EXAMINER: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include a copy of this form with next communication to applicant